

# High Performance 32x8 PROM TiW PROM Family

# 53/63S080 53/63S081 63S081A

## Features/Benefits

- 15 ns maximum access time
- Reliable titanium-tungsten fuses (TiW) guarantees greater than 98% programming yields
- Low-voltage generic programming
- Pin-compatible with standard Schottky PROMs
- PNP inputs for low input current

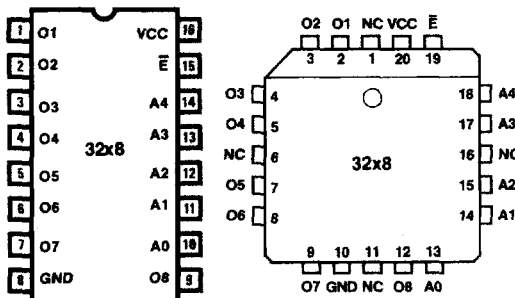
## Applications

- Programmable logic element (PLE™) 5 inputs, 8 outputs, 32 product terms per output
- Address decoder
- Priority encoder

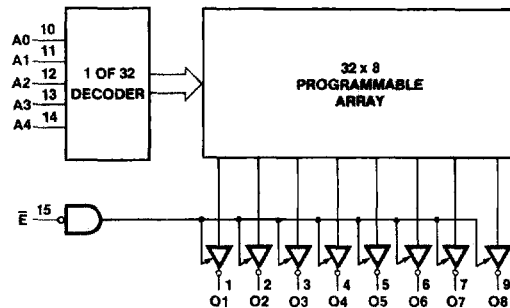
## Selection Guide

| MEMORY |              | PACKAGE    |                     | OUTPUT | PERFORMANCE | PART NUMBER  |                 |
|--------|--------------|------------|---------------------|--------|-------------|--------------|-----------------|
| SIZE   | ORGANIZATION | PINS       | TYPE                |        |             | 0°C to +75°C | -55°C to +125°C |
| 1/4 K  | 32x8         | 16<br>(20) | N,J,F,W<br>(NL),(L) | TS     | Enhanced    | 63S081A      | —               |
|        |              |            |                     | TS     | Standard    | 63S081       | 53S081          |
|        |              |            |                     | OC     |             | 63S080       | 53S080          |

## Pin Configurations



## Block Diagram



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**Monolithic  
Memories**

**Absolute Maximum Ratings**

|                                | Operating         | Programming |
|--------------------------------|-------------------|-------------|
| Supply voltage $V_{CC}$ .....  | -0.5 V to 7 V     | 12 V        |
| Input voltage .....            | -1.5 V to 7 V     | 7 V         |
| Input current .....            | -30 mA to +5 mA   |             |
| Off-state output voltage ..... | -0.5 V to 5.5 V   | 12 V        |
| Storage temperature .....      | -65 °C to +150 °C |             |

**Operating Conditions**

| SYMBOL   | PARAMETER                      | MILITARY |      |     | COMMERCIAL |      |      | UNIT |  |    |  |    |
|----------|--------------------------------|----------|------|-----|------------|------|------|------|--|----|--|----|
|          |                                | MIN      | TYP† | MAX | MIN        | TYP† | MAX  |      |  |    |  |    |
| $V_{CC}$ | Supply voltage                 | 4.5      | 5    | 5.5 | 4.75       | 5    | 5.25 | V    |  |    |  |    |
| $T_A$    | Operating free-air temperature | -55      |      |     | 125        |      |      | 0    |  | 75 |  | °C |

**Electrical Characteristics Over Operating Conditions**

| SYMBOL    | PARAMETER                      | TEST CONDITION   |                                | MIN TYP† MAX |       |  | UNIT |  |    |
|-----------|--------------------------------|--|--------------------------------|--------------|-------|--|------|--|----|
|           |                                |  |                                |              |       |  |      |  |    |
| $V_{IL}$  | Low-level input voltage        |  |                                |              | 0.8   |  | V    |  |    |
| $V_{IH}$  | High-level input voltage       |  |                                | 2            |       |  | V    |  |    |
| $V_{IC}$  | Input clamp voltage            | $V_{CC} = \text{MIN}$  | $I_I = -18 \text{ mA}$         |              | -1.5  |  | V    |  |    |
| $I_{IL}$  | Low-level input current        | $V_{CC} = \text{MAX}$  | $V_I = 0.4 \text{ V}$          |              | -0.25 |  | mA   |  |    |
| $I_{IH}$  | High-level input current       | $V_{CC} = \text{MAX}$  | $V_I = V_{CC} \text{ MAX}$     |              | 40    |  | µA   |  |    |
| $V_{OL}$  | Low-level output voltage       | $V_{CC} = \text{MIN}$  | $I_{OL} = 16 \text{ mA}$       | MIL          | 0.5   |  | V    |  |    |
|           |                                |  |                                | COM          | 0.45  |  |      |  |    |
| $V_{OH}$  | High-level output voltage*     | $V_{CC} = \text{MIN}$  | MIL $I_{OH} = -2 \text{ mA}$   | 2.4          |       |  | V    |  |    |
|           |                                |  | COM $I_{OH} = -3.2 \text{ mA}$ |              |       |  |      |  |    |
| $I_{OZL}$ | Off-state output current*      | $V_{CC} = \text{MAX}$  | $V_O = 0.4 \text{ V}$          |              | -40   |  | µA   |  |    |
| $I_{OZH}$ |                                |  | $V_O = 2.4 \text{ V}$          |              | 40    |  |      |  |    |
| $I_{CEX}$ | Open collector output current  | $V_{CC} = \text{MAX}$  | $V_O = 2.4 \text{ V}$          |              | 40    |  | µA   |  |    |
|           |                                |  | $V_O = 5.5 \text{ V}$          |              | 100   |  |      |  |    |
| $I_{OS}$  | Output short-circuit current** | $V_{CC} = 5 \text{ V}$                                       | $V_O = 0 \text{ V}$            |              | -20   |  | -90  |  | mA |
| $I_{CC}$  | Supply current                 | $V_{CC} = \text{MAX}$ All inputs grounded. All outputs open. |                                |              | 90    |  | 125  |  | mA |

**Switching Characteristics Over Operating Conditions (See standard test load)**

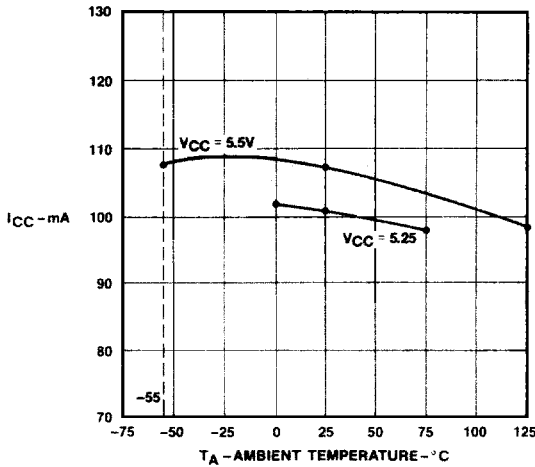
| OPERATING CONDITIONS | DEVICE TYPE    | $t_{AA}$ (ns)<br>ADDRESS ACCESS TIME |         | $t_{EA}$ AND $t_{ER}$ (ns)<br>ENABLE ACCESS TIME<br>RECOVERY TIME |     | UNIT |
|----------------------|----------------|--------------------------------------|---------|---|-----|------|
|                      |                | TYP†                                 | MAX     | TYP†  | MAX |      |
|                      |                | COMMERCIAL                           | 63S081A | 9   | 15  |      |
| 63S080, 63S081       | 9              |                                      | 25      | 9   | 20  |      |
| MILITARY             | 53S080, 53S081 | 9                                    | 35      | 9   | 30  |      |

\* Three-state only.

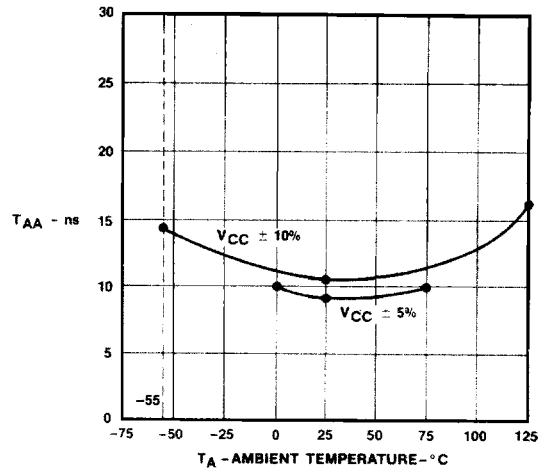
\*\* Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

† Typical at 5.0 V  $V_{CC}$  and 25°C  $T_A$ .

**Typical  $I_{CC}$  vs Temperature**

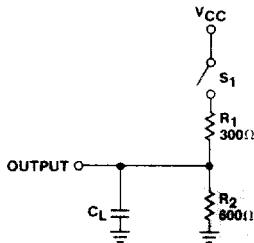


**Typical  $T_{AA}$  vs Temperature**



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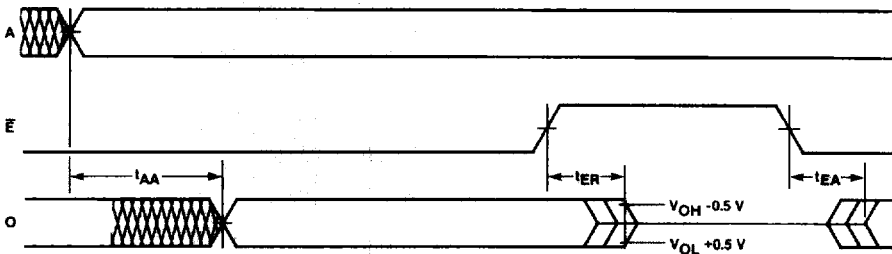
**Switching Test Load**



**Definition of Timing Diagram**

| WAVEFORM | INPUTS                          | OUTPUTS                                |
|----------|---------------------------------|--|
|          | DON'T CARE;<br>CHANGE PERMITTED | CHANGING;<br>STATE UNKNOWN             |
|          | NOT<br>APPLICABLE               | CENTER LINE IS<br>HIGH IMPEDANCE STATE |
|          | MUST BE STEADY                  | WILL BE STEADY                         |

**Definition of Waveforms**



- NOTES:
1. Input pulse amplitude 0 V to 3.0 V.
  2. Input rise and fall times 2-5 ns from 0.8 V to 2.0 V.
  3. Input access measured at the 1.5 V level.
  4.  $t_{AA}$  and  $t_{EA}$  are tested with switch  $S_1$  closed,  $C_L = 30$  pF and measured at 1.5 V output level.
  5. For open collector devices,  $t_{EA}$  and  $t_{ER}$  are measured at the 1.5 V output level with  $S_1$  closed and  $C_L = 30$  pF.
  6. For three-state devices,  $t_{EA}$  is measured at the 1.5 V output level with  $C_L = 30$  pF.  $S_1$  is open for high impedance to "1" test and closed for high impedance to "0" test.
- $t_{ER}$  is tested with  $C_L = 5$  pF.  $S_1$  is open for "1" to high impedance test, measured at  $V_{OH} - 0.5$  V output level;  $S_1$  is closed for "0" to high impedance test measured at  $V_{OL} + 0.5$  V output level.

### Commercial Programmers

Monolithic Memories PROMs are designed and tested to give a programming yield greater than 98%. If your programming yield is lower, check your programmer. It may not be properly calibrated.

Programming is final manufacturing — it must be quality-controlled. Equipment must be calibrated as a regular routine,

ideally under the actual conditions of use. Each time a new board or a new programming module is inserted, the whole system should be checked. Both timing and voltages must meet published specifications for the device.

**Remember — The best PROMs available can be made unreliable by improper programming techniques.**

#### PROM PROGRAMMING EQUIPMENT INFORMATION

##### SOURCE AND LOCATION

Data I/O Corp.  
10525 Willows Rd. N.E.  
Redmond, WA 98073

Kontron Electronics, Inc.  
630 Price Ave.  
Redwood City, CA 94063

Digelec Inc.  
586 Weddell Dr. Suite 1  
Sunnyvale, CA 94089

Stag Microsystems Inc.  
528-5 Weddell Dr.  
Sunnyvale, CA 94089

### Metal Mask Layout

